

Overview

The purpose of this notification is to communicate that Xilinx® has changed the format of the label on the PCB board, ESD bag, inner box and outer carton for Alveo™ U200, U250, U280, including any new Alveo products. There is no change to form, fit, function, or reliability.

Description

Xilinx will be changing the format of the label on the PCB board, ESD bag, inner box and outer carton for all Alveo products (U200, U250, U280, including any new Alveo products). All key information will remain on the label. The details of changes can be found in [Table 1](#) (Detail of the Label Changes) and [Figure 1](#) (Examples of Label Format). Any associated Specification Control Documents (SCDs) are also affected, except SCD part numbers which are for special labeling.

Table 1: Detail of the Label Changes

| Label | Products | Items to be Removed | Items to be Changed |
|---|---|--------------------------------|---|
| PCBA Part Number Label | All Alveo branded boards (U200, U250, U280), new Alveo products and any associated Specification Control Document (SCD) | 043 human readable information | 1. Current Serial Number (SN) format will be random |
| High Level Assembly and ESD Bag Label | | 043 human readable information | 1. Current SN format will be random 2. Combined all MAC IDs in single 2D code scan and first starting address will be human readable. Note: 2D Scan data will show all MAC IDs associated with boards sequentially (Starting address and subsequent addresses indicated sequentially in 2D scan) 3. COO will be spell out "MADE IN MY" using ISO 3166 alpha-2 code for country name |
| Inner Box Label | | NULL | 1. Current SN format will be random 2. Added COO information, UPC-A & EAN Barcodes |
| Outer Carton Label | | NULL | 1. Added the below information a. Xilinx LPN, b. PO Number, c. UPC and EAN Barcodes 2. Replaced Supplier Prod ID to Ordering SKU |

Figure 1: Examples of Label Format

| | |
|---|---|
| <p>Current PCBA Part Number Label</p>  <p>043XXXX-RR-YYWW SN: XXXRRYMDSSS</p> <p>2D Code Scan Data: XXXRRYMDSSS</p> | <p>New PCBA Part Number Label</p>  <p>SN: XABCNNNNNNNN</p> <p>2D Code Scan Data: XABCNNNNNNNN</p> |
| <p>Current HLA (High Level Assembly) and ESD Bag Label</p>  <p>043XXXX-RR-YYWW SN: XXXRRYMDSSS</p> <p>Made In Malaysia</p> <p>00:0A:35:XX:XX:X1 00:0A:35:XX:XX:X2</p>   | <p>New HLA (High Level Assembly) and ESD Bag Label</p>  <p>SN: XABCNNNNNNNN MADE IN MY</p> <p>MAC: 00-0A-35-XX-XX-X1</p>  |
| <p>Current Inner Box Label</p> <p>048XXXX RR MM/DD/YYYY</p> <p>A-UXXX-XXX-XX-X</p>  <p>SN: XXXRRYMDSSS</p>    | <p>New Inner Box Label</p> <p>048XXXX RR MM/DD/YYYY</p> <p>A-UXXX-XXX-XX-X</p> <p>UPC-A EAN SN: XABCNNNNNNNN</p>    <p>0 1234567891 2 0 123456789012</p> <p>MADE IN MY</p>   |
| <p>Current Carton Shipping Label</p> <p>PKG ID: 12345678</p>  <p>FROM: XILINX SALES INTERNATIONAL PTE LTD C/O JSI LOGISTICS (S) PTE LTD 3 CHANGI NORTH STREET2 #01-03B LOGISTECH SINGAPORE 498827</p> <p>QUANTITY: XX</p>  <p>TO: (Customer Shipping Address)</p> <p>PACKAGE WEIGHT: PACKAGE COUNT:</p> <p>XX.X KG X OF X</p> <p>XX.X LBS</p> <p>(Carrier Type) XXX</p> <p>SUPPLIER PROD ID: : A-UXXX-XXX-XX-X</p>  | <p>New Carton Shipping Label</p> <p>XILINX LPN: 123456789ABC</p>  <p>FROM: XILINX SALES INTERNATIONAL PTE LTD C/O JSI LOGISTICS (S) PTE LTD 3 CHANGI NORTH STREET2 #01-03B LOGISTECH SINGAPORE 498827</p> <p>(3S) PKG ID: XILINX+12345678</p>  <p>TO: (Customer Shipping Address)</p> <p>(Carrier Type) XXX</p> <p>(Q) QUANTITY: XX (K) PO NUMBER: XXXXXX</p>   <p>(1P) ORDERING SKU: A-UXXX-XXX-XX-X</p>  <p>PACKAGE COUNT:</p> <p>X OF X</p> <p>UPC-A EAN PACKAGE WEIGHT:</p>   <p>0 1234567891 2 0 123456789012</p> <p>XX.X KG</p> <p>XX.X LBS</p> |

Products Affected

This change affects all Alveo U200, U250, U280 and upcoming new products. All associated specification control document (SCD) devices are also affected, except SCD part numbers for special labeling.

Key Dates and Ordering Information

Xilinx will begin to cross-ship new labels for Inner Box and outer carton labels starting December 2, 2019.

Xilinx will begin to cross-ship new labels for PCBA part number, HLA and ESD bag starting February 3, 2020.

Response

No response required.

Important Notice: Xilinx Customer Notifications (XCNs, XDNs, and Quality Alerts) can be delivered via e-mail alerts sent by the Support website (<http://www.xilinx.com/support>). Register today and personalize your “Documentation and Design Advisory Alerts” area to include Customer Notifications. Xilinx Support provides many benefits, including the ability to receive alerts for new and updated information about specific products, as well as alerts for other publications such as data sheets, errata, application notes, etc. For information on how to sign up, refer to [Xilinx Answer Record 18683](#).

Revision History

The following table shows the revision history for this document.

| Date | Version | Revision |
|------------|---------|------------------|
| 11/11/2019 | 1.0 | Initial release. |

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